

MOSFET

OptiMOS™ 6 Power-Transistor, 200 V

Features

- N-channel, normal level
- Low on-resistance R_{DS(on)}
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- 175°C operating temperature
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- 100% avalanche tested

Product validation

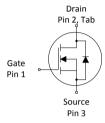
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

Parameter	Value	Unit
V_{DS}	200	V
R _{DS(on),max}	9.5	mΩ
I _D	116	А
$Q_{ m oss}$	168	nC
Q_{G}	53	nC
Q _{rr} (1000A/μs)	307	nC









Part number	Package	Marking	Related links
IPP095N20NM6	PG-TO220-3	095N20N6	-

Public

OptiMOS™ 6 Power-Transistor, 200 V IPP095N20NM6



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OptiMOS™ 6 Power-Transistor, 200 V IPP095N20NM6



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			l lmit	Note / Test condition	
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
				116		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C	
0 1)	,		-	82		$V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C	
Continuous drain current 1)	l _D	-		86	Α	$V_{\rm GS}$ =15 V, $T_{\rm C}$ =100 °C	
				13		$V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	464	А	<i>T</i> _A =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	373	mJ	$I_{\rm D}$ =56 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Davies discination	P_{tot}			300	۱۸/	<i>T</i> _C =25 °C	
Power dissipation		-	-	3.8	W	T_A =25 °C, R_{thJA} =40 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	_	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Syllibot	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	R_{thJC}		0.39	0.5		
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	R_{thJA}	A -	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	$R_{ m thJA}$		-	62		

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Limit	Note / Test can dition	
Parameter	Symbol	Min.	Тур.	Max.		Note / Test condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	200	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.7	4.5	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 186 \mu{\rm A}$	
Zero gate voltage drain current	,	-	0.1	1	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	
	I _{DSS}		10	100	μΑ	$V_{\rm DS}$ =160 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C	
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
Drain-source on-state resistance	D	-	7.2	8.7	mΩ	$V_{\rm GS}$ =15 V, $I_{\rm D}$ =62 A	
Diain-source on-state resistance	$R_{\rm DS(on)}$		8.0	9.5	11122	$V_{\rm GS}$ =10 V, $I_{\rm D}$ =62 A	
Gate resistance	R_{G}	-	3.6	-	Ω	-	
Transconductance ⁶⁾	g_{fs}	23	45	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 62 \text{ A}$	

⁶⁾ Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test condition	
Parameter	Syllibol	Min.	Тур.	Max.	Oilit	Note / Test condition	
Input capacitance ⁷⁾	C _{iss}		4200	5500			
Output capacitance 7)	Coss		660	860	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =100 V, f =1 MHz	
Reverse transfer capacitance 7)	C _{rss}		24	42			
Turn-on delay time	$t_{\sf d(on)}$		15			$V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =31 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r		30				
Turn-off delay time	$t_{ m d(off)}$	-	28]-	ns		
Fall time	t _f		11				

⁷⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Linit	Note / Test condition	
raiainetei	Symbol	Min.	Тур.	Max.	Oille	Note / Test condition	
Gate to source charge	Q_{gs}		27	-	nC		
Gate charge at threshold	$Q_{\mathrm{g(th)}}$		15.4	-	nC		
Gate to drain charge ⁹⁾	Q_{gd}		10.4	15.6	nC	 // =100 \/ / =21 \A \/ =0 to 10 \/	
Switching charge	Q_{sw}		22	-	nC	$V_{\rm DD}$ =100 V, $I_{\rm D}$ =31 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total ⁹⁾	$Q_{ m g}$		53	66	nC		
Gate plateau voltage	$V_{ m plateau}$		6.5	-	V		
Output charge ⁹⁾	$Q_{\rm oss}$	_	168	223	nC	V _{DS} =100 V, V _{GS} =0 V	

⁸⁾ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

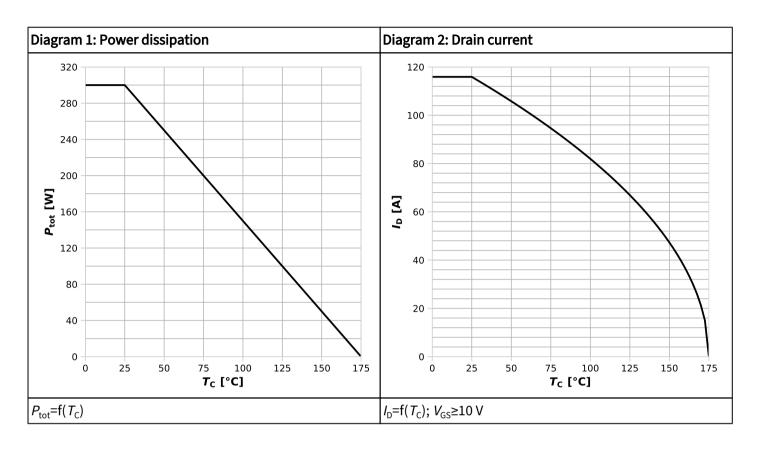
Parameter	Symbol	Values			Linit	Note / Test condition	
raiametei	Syllibot	Min.	Тур.	Max.	Oille	Note / Test condition	
Diode continuous forward current	I _S			116	Α	T −25 °C	
Diode pulse current	I _{S,pulse}	_	_	464	Α	<i>T</i> _C =25 °C	
Diode forward voltage	$V_{\rm SD}$	-	0.89	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =62 A, $T_{\rm j}$ =25 °C	
Reverse recovery time	$t_{\rm rr}$		58	-	ns	1/_100\/	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	78	156	$R_{\rm R} = 100 \text{ V}, I_{\rm F} = 31 \text{ A}, \alpha I_{\rm F} / \alpha t$	$V_{\rm R}$ =100 V, $I_{\rm F}$ =31 A, d $i_{\rm F}$ /d t =100 A/ μ s	
Reverse recovery time	$t_{\rm rr}$		31	-	ns	1/_100\/	
Reverse recovery charge ¹⁰⁾	$Q_{\rm rr}$	-	307 614 nC $V_R = 100 \text{ V}, I_F$		$V_{\rm R}$ =100 V, $I_{\rm F}$ =31 A, d $i_{\rm F}$ /d t =1000 A/ μ s		

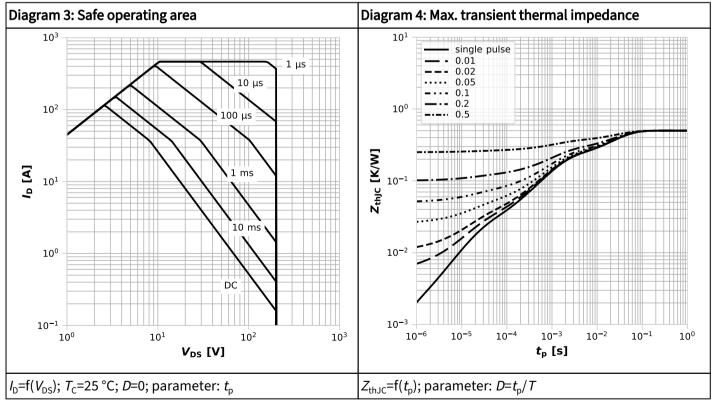
¹⁰⁾ Defined by design. Not subject to production test.

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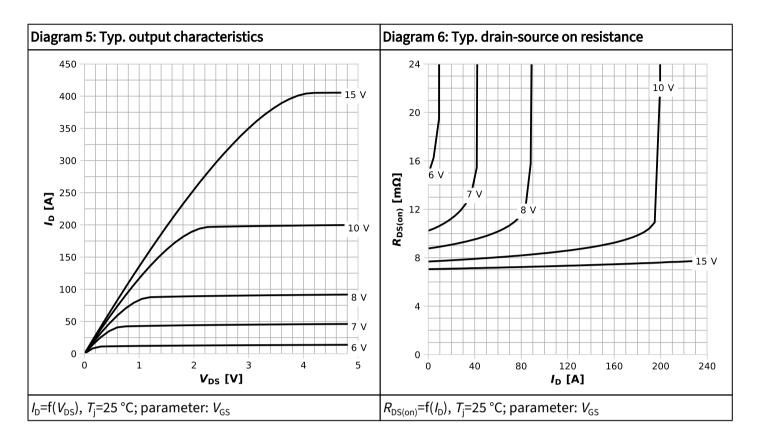


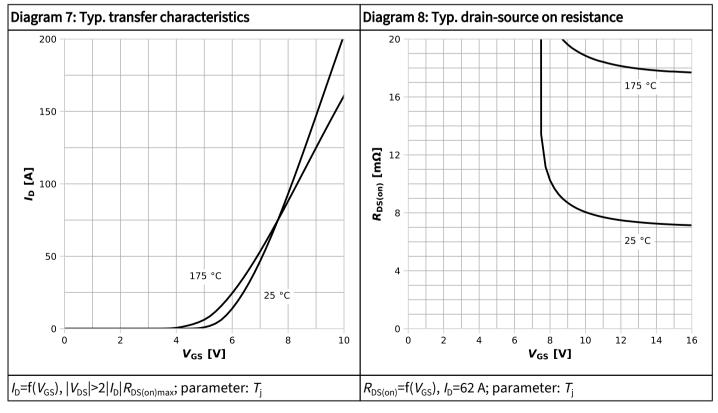
4 Electrical characteristics diagrams



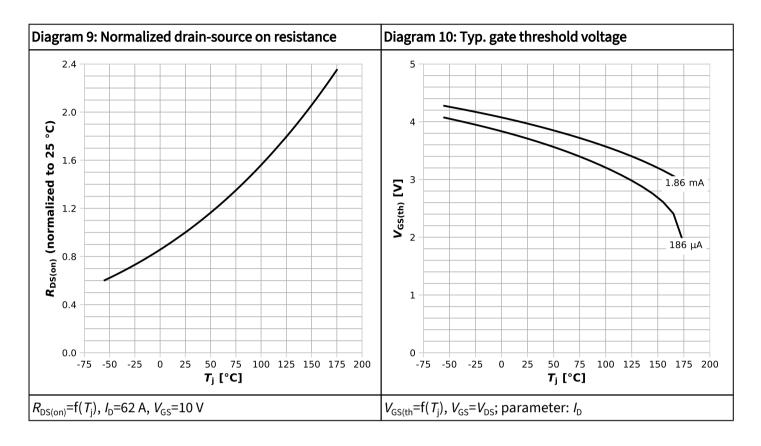


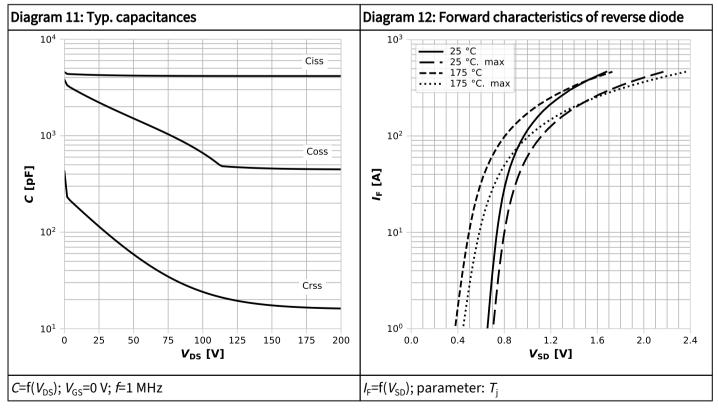




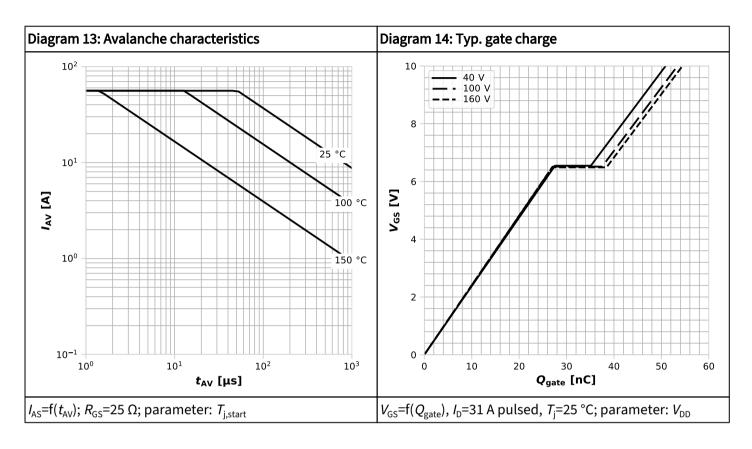


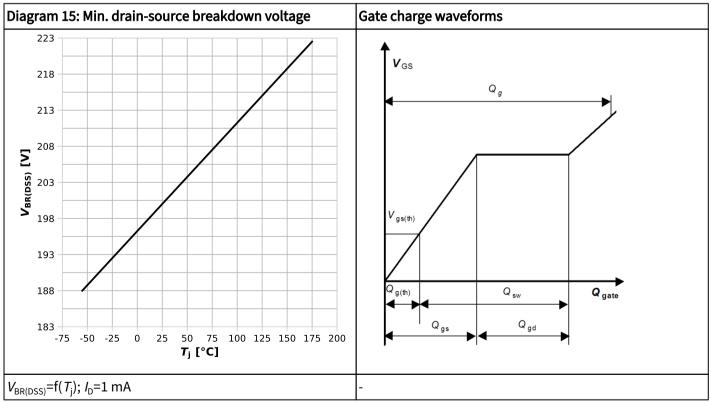














5 Package outlines

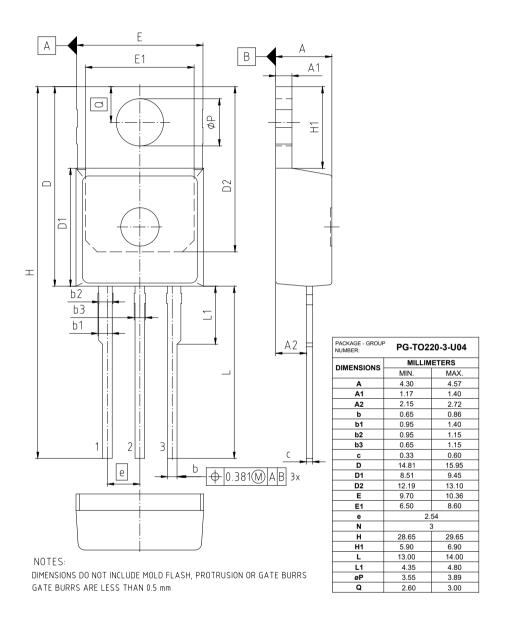


Figure 1 Outline PG-TO220-3, dimensions in mm

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Revision history

IPP095N20NM6

Revision 2025-03-25, Rev. 1.0

Previous revisions

Revision	Date	Subjects (major changes since last revision)
1.0	2025-03-25	Release of final datasheet

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